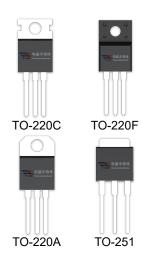
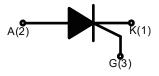


### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, TYN616 series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.





### **MAIN FEATURES**

Symbol	JCT616	JCT816	
V <sub>DRM</sub> / V <sub>RRM</sub>	600V	800V	
I <sub>T(RMS)</sub>	16A		
I <sub>GT</sub>	≤15mA		

## **ABSOLUTE MAXIMUM RATINGS**

Parame	Symbol	Value	Unit	
Storage junction temperature range		T <sub>stg</sub>	-40-150	$^{\circ}\!\mathbb{C}$
Operating junction temperature range		Tj	-40-150	$^{\circ}\!\mathbb{C}$
Repetitive peak off-state voltage(T <sub>j</sub> =25℃)		V <sub>DRM</sub>	600/800	V
Repetitive peak reverse voltage(T <sub>j</sub> =25℃)		V <sub>RRM</sub>	600/800	V
RMS on-state current	TO-220A(Ins) / TO-220F(Ins) (Tc=100°C) TO-251/ TO-220C TO-220A(Non-Ins) (Tc=120°C)	I <sub>T(RMS)</sub>	16	A



Non repetitive surge peak on-state current (tp=10ms)	I <sub>TSM</sub>	180	А
I <sup>2</sup> t value for fusing (tp=10ms)	l²t	162	A <sup>2</sup> s
Critical rate of rise of on-state current $(I_G=2\times I_{GT})$	dl/dt	50	A/µs
Peak gate current	I <sub>GM</sub>	4	Α
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Peak gate power	Рсм	5	W

# **ELECTRICAL CHARACTERISTICS** (T<sub>j</sub>=25°C unless otherwise specified)

Symbol	Took Condition	Value			11:4
	Test Condition	MIN.	TYP.	MAX.	Unit
lgт	V -40V D -220	-	-	15	mA
V <sub>G</sub> T	V <sub>D</sub> =12V R <sub>L</sub> =33Ω	-	-	1.3	V
V <sub>GD</sub>	$V_D=V_{DRM}T_j=150^{\circ}C$ RL=3.3K $\Omega$	0.2	-	-	V
IL	I <sub>G</sub> =1.2I <sub>GT</sub>	-	-	60	mA
I <sub>H</sub>	I <sub>T</sub> =500mA	-	-	50	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =150℃	200	-	-	V/µs

## **STATIC CHARACTERISTICS**

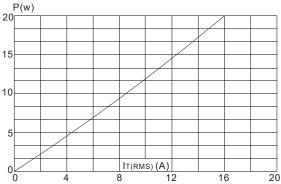
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =32A tp=380μs	Tj=25℃	1.55	V
IDRM	V <sub>D</sub> =V <sub>DRM</sub> V <sub>R</sub> =V <sub>RRM</sub>	Tj=25℃	5	μA
I <sub>RRM</sub>		T <sub>j</sub> =150℃	2	mA

# **THERMAL RESISTANCES**

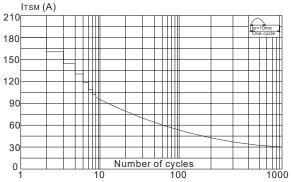
Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-220A(Ins)/ TO-220F(Ins)	2.4	°C/W
		TO-220A(Non-Ins) TO-220C	1.1	
		TO-251	1.4	



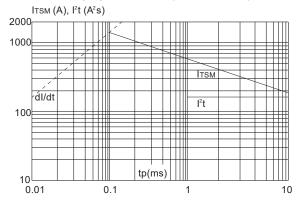
**FIG.1** Maximum power dissipation versus RMS on-state current



**FIG.3:** Surge peak on-state current versus number of cycles



**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<10ms, and corresponging value of I<sup>2</sup>t (dI/dt<50A/µs)



**FIG.2:** RMS on-state current versus case temperature

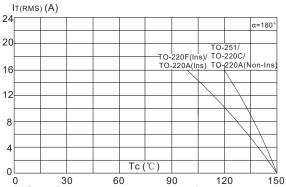
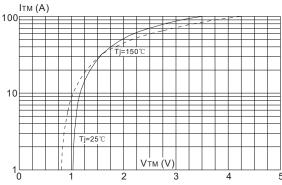


FIG.4: On-state characteristics (maximum values)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature

